

Inventor: Joseph C. Lee
Application No. 10/670,873
Title: Wafer Mobile Phone Platform System
REPLACEMENT SHEET

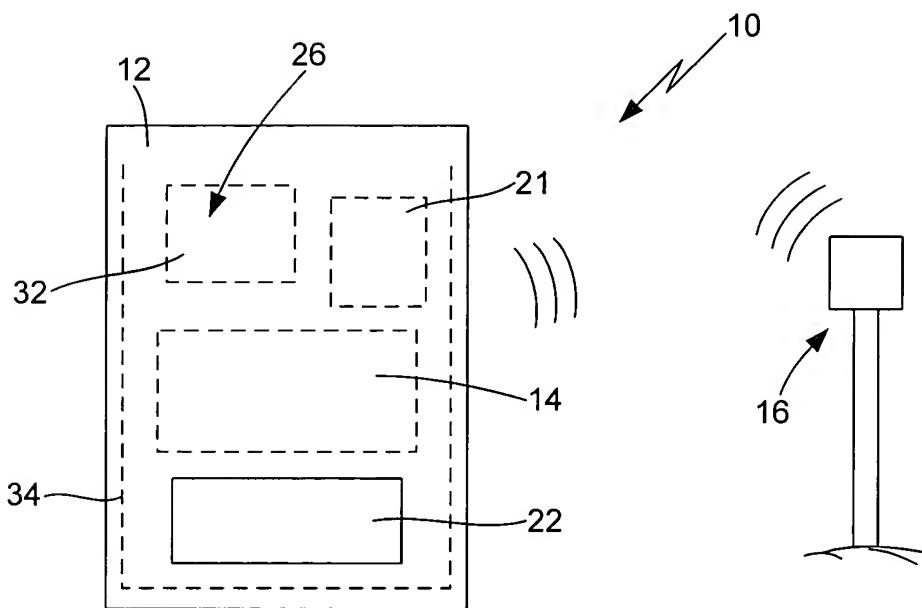


FIG. 1

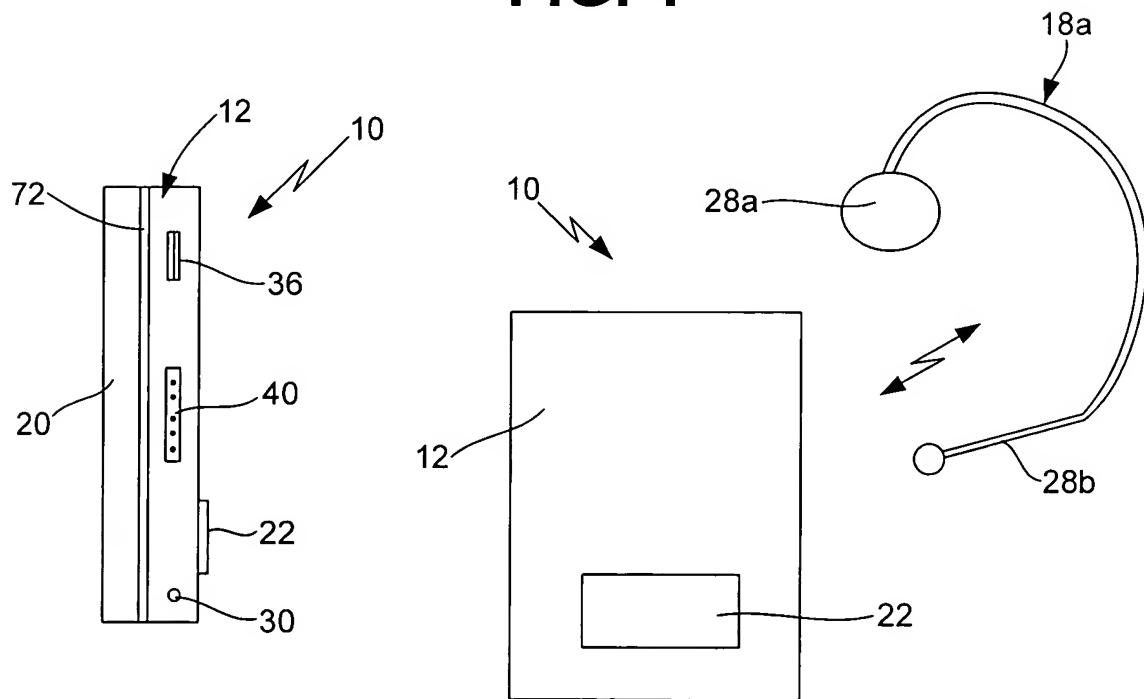
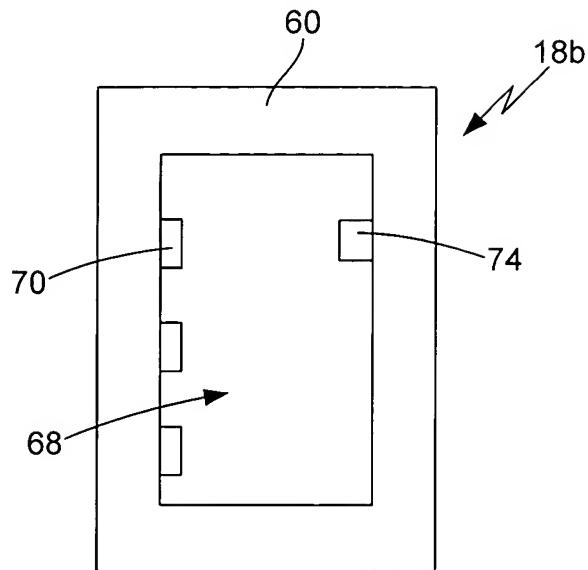
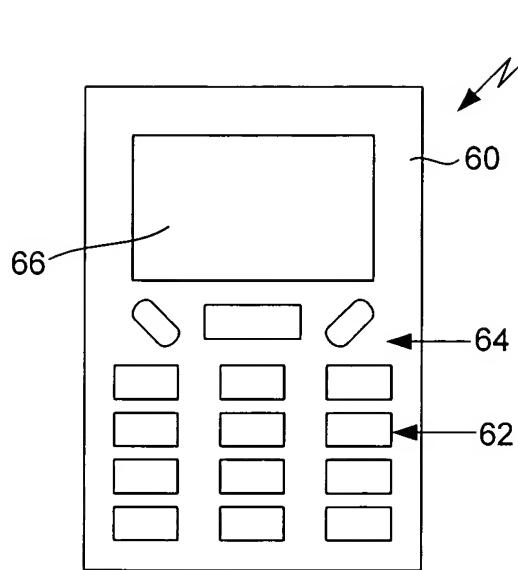
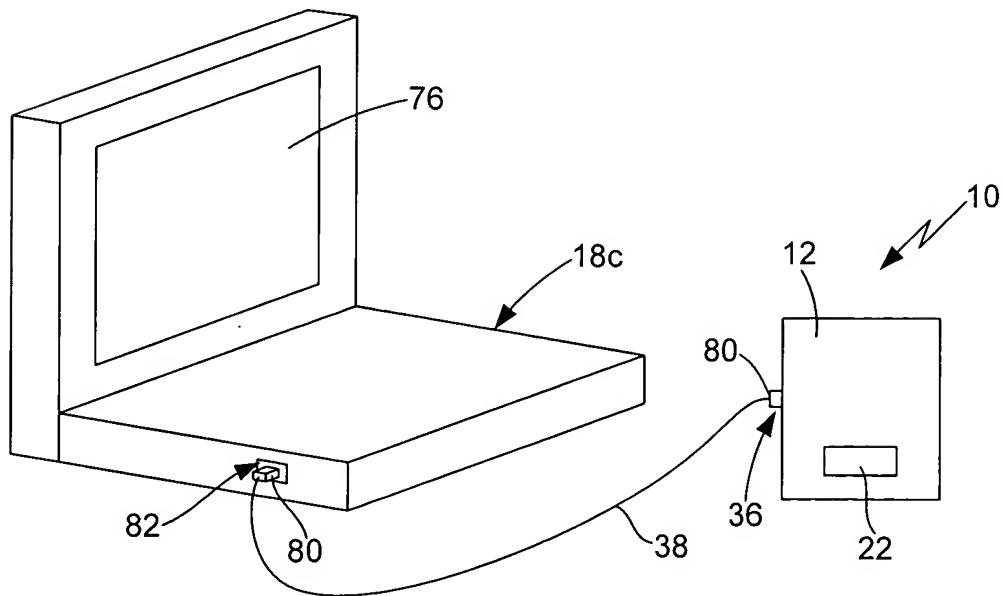
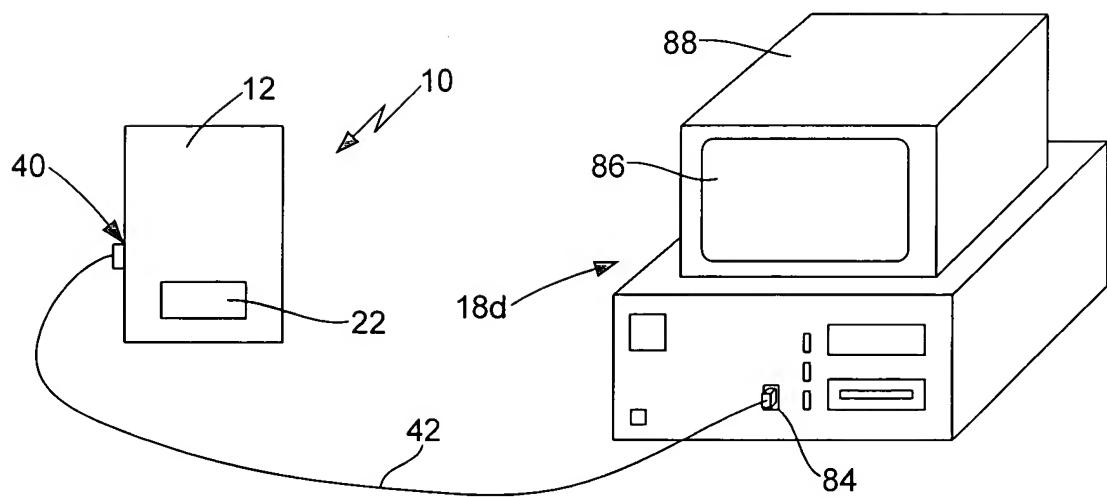
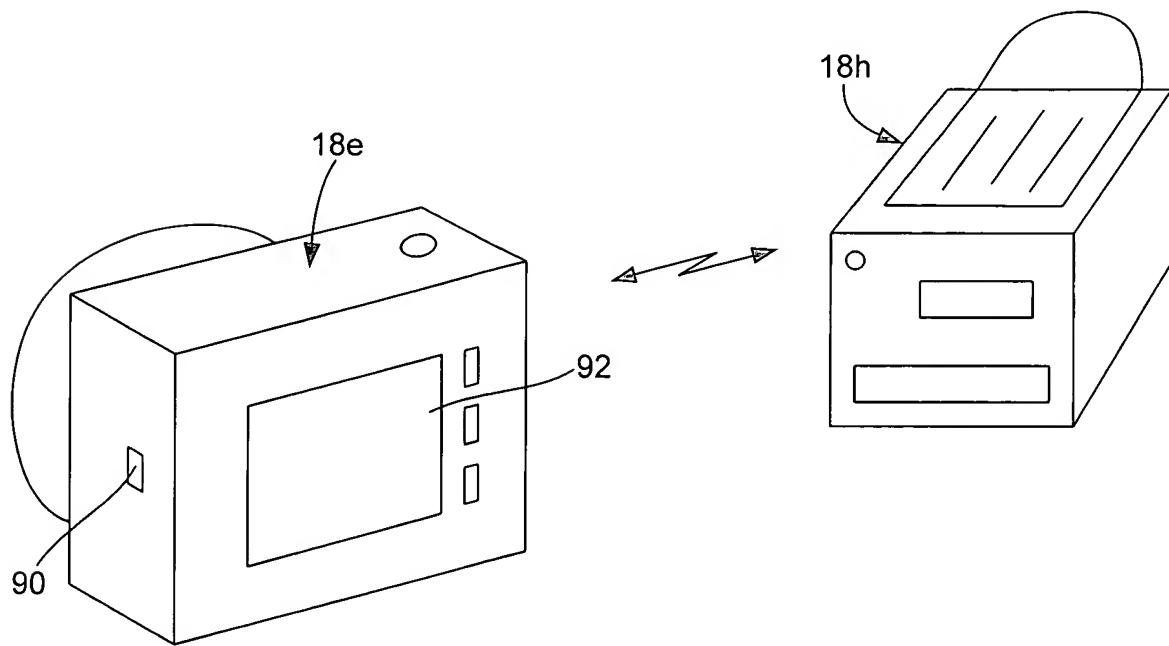


FIG. 2

FIG. 3

**FIG. 4****FIG. 5****FIG. 6**

**FIG. 7****FIG. 8**

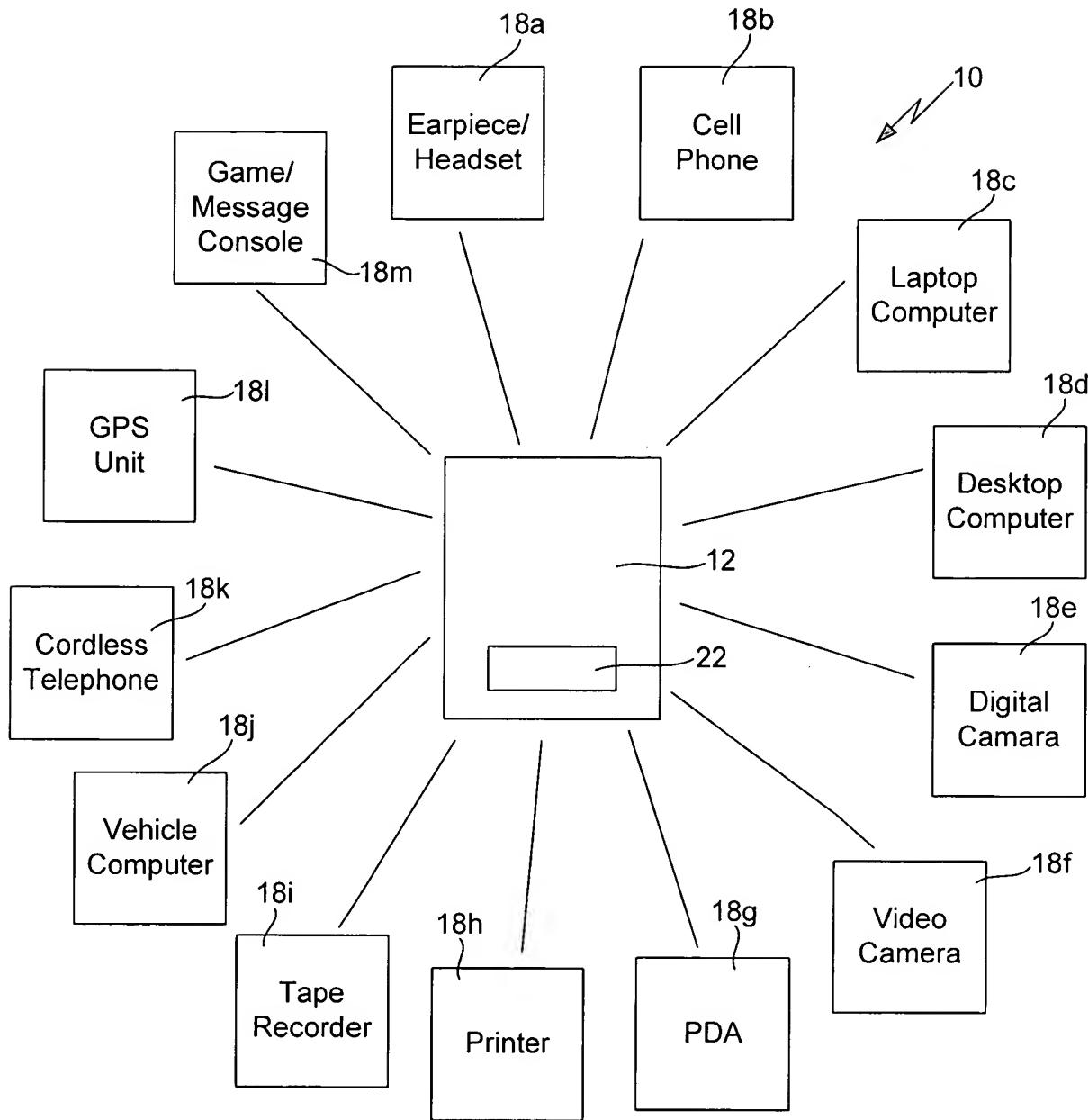


FIG. 9